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(54) Ion implanter end station.

(includes a wafer support (38) which is rotatable about a first axis (80) extending substantially along a wafer diameter in the plane defined by the wafer surface, and about a second axis (88) perpendicular to the first axis and extending through the center of

the wafer. The drive systems (62, 63) for providing rotation of the wafer support are operable independently of one another and include stepper motors (73, 82) mounted outside the vacuum chamber (32) of the implanter.



